Lead-free Green

PI6CG334Q

## 4-Output PCle Gen 6 Clock Generator For Automotive Applications

## Description

The DIODES PI6CG334Q is a 4 -output very-low-power PCIe ${ }^{*}$ Gen 1/Gen 2/Gen 3/Gen 4/Gen 5/Gen 6 clock generator. It uses 25 MHz crystal or CMOS reference as an input to generate the 100 MHz low-power differential HCSL outputs with on-chip terminations. The on-chip termination can save 16 external resistors and make layout easier. An additional buffered reference output is provided to serve as a low-noise reference for other circuitry. It uses Diodes' proprietary PLL design to achieve very-low jitter that meets PCIe Gen 1/Gen 2/Gen 3/Gen 4/Gen 5/Gen 6 requirements. It also provides various options such as different slew rate and amplitude through SMBUS, so users can configure the device easily to get the optimized performance for their individual boards. The device also supports selectable spread-spectrum options to reduce EMI for various applications.

## Block Diagram



## Features

- 3.3V Supply Voltage
- Crystal/CMOS Input: 25 MHz
- Four Differential Low Power HCSL Outputs with On-Chip Termination
- Individual Output Enable
- Reference CMOS Output
- Programmable Slew Rate and Output Amplitude for Each Output
- Differential Outputs Blocked until PLL is Locked
- Selectable $0 \%,-0.25 \%$, or $-0.5 \%$ Spread on Differential Outputs
- Strapping Pins or SMBus for Configuration
- Differential Output-To-Output Skew $<50$ ps
- Very-Low Jitter Outputs
- PCIe 6.0 Common Clock (RMS) Jitter <0.04ps
- Differential Cycle-To-Cycle Jitter <50ps
- PCIe Gen 1/Gen 2/Gen 3/Gen 4/Gen 5/Gen 6 Compliant
- Support Automotive Grade 2
- Totally Lead-Free \& Fully RoHS Compliant (Notes 1 \& 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The PI6CG334Q is suitable for automotive applications requiring specific change control; this part is AEC-Q100 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.
https://www.diodes.com/quality/product-definitions/
- Packaging (Pb-free \& Green):
- 32 -Contact, $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ WQFN (ZHW)

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## Pin Configuration



## Pin Description

| Pin \# | Pin Name | Type |  | Description |
| :---: | :---: | :---: | :---: | :---: |
| 1, 15, 26, 30 | GND | Power |  | Ground pin |
| 2 | XTAL_IN/CLK | Input |  | Crystal input or CMOS reference input |
| 3 | XTAL_OUT | Output |  | Crystal output |
| 4 | V DD_OSC | Power |  | Power supply for oscillator circuitry, nominal 3.3V |
| 5 | VDD_REFOUT | Power |  | Power supply for buffered CMOS output |
| 6 | SADR/REFOUT | Input/ Output | CMOS | Latch to select SMBus Address or LVCMOS REFOUT. This pin has an internal pulldown. |
| 7 | SCLK | Input | CMOS | SMBUS clock input, 3.3V tolerant |
| 8 | SDATA | Input/ Output | CMOS | SMBUS Data line, 3.3V tolerant |
| 9 | V DD_DIG | Power |  | Power supply for digital circuitry, nominal 3.3V |
| 10 | GND_REF | Power |  | Ground for REFOUT |
| 11 | GND_DIG | Power |  | Ground for digital circuitry |
| 12 | OE0\# | Input | CMOS | Active low input for enabling Q0 pair. This pin has an internal pull-down. $1=$ disable outputs, $0=$ enable outputs |
| 13 | Q0+ | Output | HCSL | Differential true clock output |
| 14 | Q0- | Output | HCSL | Differential complementary clock output |
| 16,25 | $\mathrm{V}_{\text {DDO }}$ | Power |  | Power supply for differential outputs |

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| Pin \# | Pin Name | Type |  | Description |
| :---: | :---: | :---: | :---: | :---: |
| 17 | Q1+ | Output | HCSL | Differential true clock output |
| 18 | Q1- | Output | HCSL | Differential complementary clock output |
| 19 | OE1\# | Input | CMOS | Active low input for enabling Q1 pair. This pin has an internal pull-down. $1=$ disable outputs, $0=$ enable outputs |
| 20 | GNDA | Power |  | Ground for analog circuitry |
| 21 | $\mathrm{V}_{\text {DDA }}$ | Power |  | Power supply for analog circuitry |
| 22 | Q2+ | Output | HCSL | Differential true clock output |
| 23 | Q2- | Output | HCSL | Differential complementary clock output |
| 24 | OE2\# | Input | CMOS | Active low input for enabling Q2 pair. This pin has an internal pull-down. $1=$ disable outputs, $0=$ enable outputs |
| 27 | Q3+ | Output | HCSL | Differential true clock output |
| 28 | Q3- | Output | HCSL | Differential complementary clock output |
| 29 | OE3\# | Input | CMOS | Active low input for enabling Q3 pair. This pin has an internal pull-down. $1=$ disable outputs, $0=$ enable outputs |
| 31 | PD\# | Input | CMOS | Input notifies device to sample latched inputs and start up on first high assertion. Low enters Power Down Mode, subsequent high assertions exit Power Down Mode. This pin has internal pullup resistor. |
| 32 | SS_SEL_TRI | Input | Tri-level | Latched select input to select spread-spectrum amount at initial power up. $1=0.5 \%$ spread, $M=$ Spread off, $0=$ Spread off. This pin has both internal pull-up and pull-down. Refer to SMBUS byte_1 bit 4, $3=$ ' 01 ' to get $-0.25 \%$ spread. |
| Epad | GND | Power |  | Connect to ground |

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## SMBus Address Selection Table

|  | SADR | Address | +Read/Write Bit |
| :--- | :---: | :---: | :---: |
| State of SADR on First Application of PD\# | 0 | 1101000 | X |
|  | 1 | 1101010 | X |

Power Management Table ${ }^{(3)}$

| PD\# | SMBus OE bit | OEn\# | Qn+ | Qn- | REFOUT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | X | X | Low $^{(1)}$ | Low $^{(1)}$ | HiZ $^{(2)}$ |
| 1 | 1 | 0 | Running | Running | Running |
| 1 | 1 | 1 | Disabled $^{(1)}$ | Disabled $^{(1)}$ | Running |
| 1 | 0 | X | Disabled $^{(1)}$ | Disabled $^{(1)}$ | Disabled $^{(4)}$ |

1. The output state is set by $B 11[1: 0]$ (Low/Low default).
2. REF is Hi-Z until the 1st assertion of PD\# high. After this, when PD\# is low, REF is disabled. If Byte 3 , bit $5=1$, then REF is running
3. Input High/ Low defined at default values for device.
4. See SMBUs Byte 3, bit 4 .

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## Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)
Storage Temperature $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Supply Voltage to Ground Potential, $\mathrm{V}_{\mathrm{DDxx}}$ $\qquad$ -0.5 V to +4.6 V
Input Voltage $\qquad$ -0.5 V to $\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$, not exceed 4.6 V
SMBus, Input High Voltage 3.6 V
$\qquad$
Max Junction Temperature $\qquad$

## Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## Operating Conditions

Temperature $=\mathrm{T}_{\mathrm{A}}$; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DDO, }}$ <br> $\mathrm{V}_{\mathrm{DDA}}$, <br> VDD_OSC, <br> VDD_DIG, <br> VDD_RE- <br> FOUT | Power Supply Voltage |  | 3.135 | 3.3 | 3.465 | V |
| $\mathrm{I}_{\text {DDA }}$ | Analog Power Supply Current | All outputs active @ 100MHz |  | 22 | 25 | mA |
| IDD | Power Supply Current | All $V_{D D}$, except $V_{\text {DDA }}$ and $V_{\text {DDO }}$, All outputs active @ 100 MHz |  | 17 | 20 | mA |
| $\mathrm{I}_{\mathrm{DDO}}$ | IO Power Supply Current ${ }^{(3)}$ | VDDO, <br> All outputs active @ 100 MHz |  | 27 | 31 | mA |
| IDDA_WL | Analog Power Supply Wake-onLAN ${ }^{(1)}$ Current | Q outputs off, REF output running |  | 0.5 | 1 | mA |
| IDD_WL | Power Supply Wake-on-LAN ${ }^{(1)}$ Current | All $V_{\text {DD }}$, except $V_{\text {DDA }}$ and $V_{\text {DDO }}$, Q outputs off, REF output running |  | 3 | 6 | mA |
| IDDO_WL | Power Supply Wake-on-LAN ${ }^{(1)}$ Current for Outputs | Q outputs off, REF output running |  | 1 | 2 | mA |
| IDDA_PD | Analog Power Supply Power Down ${ }^{(2)}$ Current | All outputs off |  | 0.5 | 1 | mA |
| IDDO_PD | IO Power Down ${ }^{(2)}$ Current | All outputs off |  | 1 | 2 | mA |
| IDD_PD | Power Supply Power Down ${ }^{(2)}$ Current | All outputs off |  | 1 | 2 | mA |
| $\mathrm{T}_{\text {A }}$ | Ambient Temperature | Automotive grade | -40 |  | 105 | ${ }^{\circ} \mathrm{C}$ |

## Note:

1. Wake-on-LAN mode: PD\# = '0' Byte 3 , bit $5=$ ' 1 '.
2. Power down mode: PD\# = '0' Byte 3, bit $5=$ ' 0 '.
3. Outputs drive 5 inch trace.
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## Input Electrical Characteristics

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{\mathrm{pu}}$ | Internal Pullup Resistance |  |  | 120 |  | $\mathrm{~K} \Omega$ |
| $\mathrm{R}_{\mathrm{dn}}$ | Internal Pulldown Resistance |  |  | 120 |  | $\mathrm{~K} \Omega$ |
| C $_{\text {XTAL }}$ | Internal Capacitance on X_IN <br> and X_OUT pins |  |  | 8 |  | pF |
| LPIN | Pin Inductance |  |  |  | 7 | nH |

## Crystal Characteristic

| Parameters | Description | Min. | Typ | Max. | Units |
| :--- | :--- | :---: | :---: | :---: | :---: |
| OSCmode | Mode of Oscillation | Fundamental |  |  |  |
| FREQ | Frequency |  | 25 |  | MHz |
| ESR $^{(1)}$ | Equivalent Series Resistance |  |  | 50 | $\Omega$ |
| Cload | Load Capacitance |  | 8 |  | pF |
| Cshunt | Shunt Capacitance |  |  | 7 | pF |
| - | Drive Level |  | 200 | $\mu \mathrm{~W}$ |  |

Note:

1. ESR value is dependent upon frequency of oscillation.

## SMBus Electrical Characteristics

Temperature $=T_{A}$; Supply voltages per normal operation conditions; See test circuits for the load conditions.

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| V ${ }_{\text {DDSMB }}$ | Nominal Bus Voltage |  | 2.7 |  | 3.6 | V |
| $\mathrm{V}_{\text {IHSMB }}$ | SMBus Input High Voltage | SMBus, $\mathrm{V}_{\text {DDSMB }}=3.3 \mathrm{~V}$ | 2.1 |  | 3.6 | V |
|  |  | SMBus, $\mathrm{V}_{\text {DDSMB }}<3.3 \mathrm{~V}$ | $\begin{gathered} 0.65 \\ \text { V DDSMB }^{2} \end{gathered}$ |  |  |  |
| $\mathrm{V}_{\text {ILSMB }}$ | SMBus Input Low Voltage | SMBus, $\mathrm{V}_{\text {DDSMB }}=3.3 \mathrm{~V}$ |  |  | 0.8 | V |
|  |  | SMBus, $\mathrm{V}_{\text {DDSMB }}<3.3 \mathrm{~V}$ |  |  | 0.8 |  |
| $\mathrm{I}_{\text {SMBSINK }}$ | SMBus Sink Current | SMBus, at V ${ }_{\text {OLSMB }}$ | 4 |  |  | mA |
| V | SMBus Output Low Voltage | SMBus, at ISMBSINK |  |  | 0.4 | V |
| $\mathrm{f}_{\text {MAXSMB }}$ | SMBus Operating Frequency | Maximum frequency |  |  | 500 | kHz |
| $\mathrm{t}_{\text {RMSB }}$ | SMBus Rise Time | (Max $\left.\mathrm{V}_{\text {IL }}-0.15\right)$ to ( $\mathrm{Min} \mathrm{V}_{\mathrm{IH}}+0.15$ ) |  |  | 1000 | ns |
| $\mathrm{t}_{\text {FMSB }}$ | SMBus Fall Time | $\left(\mathrm{Min} \mathrm{V}_{\mathrm{IH}}+0.15\right)$ to $\left(\mathrm{Max} \mathrm{V}_{\mathrm{IL}}-0.15\right)$ |  |  | 300 | ns |

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## Spread Spectrum Characteristic

Temperature $=T_{A}$; Supply voltages per normal operation conditions; See test circuits for the load conditions.

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {MOD }}$ | SS Modulation Frequency | Triangular modulation | 30 | 31.8 | 33 | kHz |

## LVCMOS DC Electrical Characteristics

Temperature $=\mathrm{T}_{\mathrm{A}}$; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IH }}$ | Input High Voltage | Single-ended inputs, except SMBus | $\begin{aligned} & 0.75 \\ & V_{\mathrm{DD}} \end{aligned}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}} \\ & +0.3 \end{aligned}$ | V |
| $\mathrm{V}_{\text {IM }}$ | Input Mid Voltage | SS_SEL_TRI | $0.4 \mathrm{~V}_{\text {DD }}$ | $0.5 \mathrm{~V}_{\mathrm{DD}}$ | $0.6 \mathrm{~V}_{\text {DD }}$ | V |
| $\mathrm{V}_{\text {IL }}$ | Input Low Voltage | Single-ended inputs, except SMBus | -0.3 |  | $\begin{aligned} & 0.25 \\ & \mathrm{~V}_{\mathrm{DD}} \end{aligned}$ | V |
| $\mathrm{I}_{\mathrm{IH}}$ | Input High Current | Single-ended inputs, $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ |  |  | 5 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}$ | Input Low Current | Single-ended inputs, $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ | -5 |  |  | $\mu \mathrm{A}$ |
| IIH | Input High Current | Single-ended inputs with pullup/pulldown resistor, $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ |  |  | 50 | $\mu \mathrm{A}$ |
| IIL | Input Low Current | Single-ended inputs with pullup/pulldown resistor, $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ | -50 |  |  | $\mu \mathrm{A}$ |
| VOH | Output High Voltage | REFOUT, except SMBus; $\mathrm{IOH}=-2 \mathrm{~mA}$ | $\begin{gathered} 0.8 \times \\ \mathrm{V}_{\text {DD_ }} \\ \text { REFOUT } \end{gathered}$ |  |  | V |
| VOL | Output Low Voltage | REFOUT, except SMBus; $\mathrm{I}_{\text {OL }}=2 \mathrm{~mA}$ |  |  | $0.2 \times$ <br> $\mathrm{V}_{\mathrm{DD}}$ Refout | V |
| Rout | CMOS Output Impedance |  |  | 20 |  | $\Omega$ |
| $\mathrm{CIIN}^{\text {IN }}$ | Input Capacitance |  | 1.5 |  | 5 | pF |

## LVCMOS AC Characteristics

Temperature $=\mathrm{T}_{\mathrm{A}}$; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {INPUT }}$ | Input Frequency | XTAL_IN/CLK |  | 25 |  | MHz |
| t RIN | Input Rise Time | Single-ended inputs |  |  | 5 | ns |
| tfin | Input Fall Time | Single-ended inputs |  |  | 5 | ns |
| tsTAB | Clock Stabilization | From power up and after input clock stabi- <br> lization or deassertion of PD\# to first clock |  | 0.75 | 1 | ms |
| toeLat | Output Enable Latency | Q start after OE\# assertion <br> Q stop after OE\# deassertion | 1 |  | 3 | clocks |

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| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $t_{\text {PDLAT }}$ | PD\# Deassertion | Differential outputs enable after PD\# deassertion |  | 20 | 300 | $\mu \mathrm{s}$ |
| tPERIOD | REFOUT Clock Period | REFOUT, assume input is at 25 MHz |  | 40 |  | ns |
| $\mathrm{f}_{\text {ACC }}$ | REFOUT Frequency Accuracy ${ }^{(1)}$ | REFOUT, long term accuracy to input |  | 0 |  | ppm |
| tslew | REFOUT Slew Rate ${ }^{(1)}$ | Byte $3=1 \mathrm{~F}, 20 \%$ to $80 \%$ of $\mathrm{V}_{\text {DDREF }}$ | 0.8 | 1.4 | 2 | V/ns |
|  |  | Byte $3=5 \mathrm{~F}, 20 \%$ to $80 \%$ of $\mathrm{V}_{\text {DDREF }}$ | 1.5 | 2.4 | 3.2 | V/ns |
|  |  | Byte $3=9 \mathrm{~F}, 20 \%$ to $80 \%$ of $\mathrm{V}_{\text {DDREF }}$ | 2.0 | 3.0 | 3.9 | V/ns |
|  |  | Byte $3=\mathrm{DF}, 20 \%$ to $80 \%$ of $\mathrm{V}_{\text {DDREF }}$ | 2.3 | 3.2 | 4.5 | V/ns |
| $t_{\text {DC }}$ | REFOUT Duty Cycle ${ }^{(1)}$ | $\mathrm{V}_{\mathrm{T}}=\mathrm{V}_{\mathrm{DD}} / 2 \mathrm{~V}$, driven by a Xtal | 45 | 50 | 55 | \% |
| $\mathrm{t}_{\text {DCDIS }}$ | REFOUT Duty Cycle Distortion | $\mathrm{V}_{\mathrm{T}}=\mathrm{V}_{\mathrm{DD}} / 2 \mathrm{~V}$, driven by an external source | -2 | 0 | +2 | \% |
| $\mathrm{t}_{\text {IITCC }}$ | REFOUT Cycle-Cycle Jitter | $\mathrm{V}_{\mathrm{T}}=\mathrm{V}_{\mathrm{DD}} / 2 \mathrm{~V}$, driven by a Xtal |  | 70 | 150 | ps |
| $\mathrm{t}_{\text {IITPH }}$ | REFOUT Phase Jitter, RMS | 12 kHz to 5 MHz , SSC off, driven by a Xtal |  | 0.16 | 0.3 | ps |
|  |  | 12 kHz to 5 MHz , SSC on, driven by a Xtal |  | 0.9 | 1.5 | ps |
| $\mathrm{t}_{\text {JITN }}$ | Noise Floor | 1 kHz offset, driven by a Xtal |  | -149 | -135 | $\mathrm{dBc} / \mathrm{Hz}$ |
|  |  | 10 kHz offset to Nyquist, driven by a Xtal |  | -158 | -140 | $\mathrm{dBc} / \mathrm{Hz}$ |

## Note:

1. Guaranteed by design and characterization-not $100 \%$ tested in production.

## HCSL Output Characteristics

Temperature $=T_{A}$; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Condition | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | Output Voltage High ${ }^{(1)}$ | Statistical measurement on single-ended signal using oscilloscope math function | 660 | 784 | 850 | mV |
| $\mathrm{V}_{\mathrm{OL}}$ | Output Voltage Low ${ }^{(1)}$ |  | -150 |  | 150 | mV |
| V OMAX | Output Voltage Maximum ${ }^{(1)}$ | Measurement on single ended signal using absolute value |  | 816 | 1150 | mV |
| Vomin | Output Voltage Minimum ${ }^{(1)}$ |  | -300 | -42 |  | mV |
| VOC | Output Cross Voltage ${ }^{(1,2,4)}$ |  | 250 | 430 | 550 | mV |
| DVOC | VOC Magnitude Change ${ }^{(1,2,5)}$ |  |  | 12 | 140 | mV |

## Note:

1. At default SMBUS amplitude settings.
2. Guaranteed by design and characterization-not $100 \%$ tested in production.
3. Measured from differential waveform.
4. This one is defined as voltage where $\mathrm{Q}+=\mathrm{Q}$ - measured on a component test board and only applied to the differential rising edge.
5. The total variation of all Vcross measurements in any particular system. This is a subset of Vcross_min/max allowed.

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## HCSL Output AC Characteristics

Temperature $=\mathrm{T}_{\mathrm{A}}$; Supply voltages per normal operation conditions; See test circuits for the load conditions.

| Symbol | Parameters | Condition | Min. | Typ. | Max. | Spec <br> Limit | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| fout | Output Frequency |  |  | 100 |  |  | MHz |
| $\mathrm{t}_{\mathrm{RF}}$ | Slew Rate ${ }^{(1,2,3)}$ | Scope averaging on fast setting | 2.5 | 3.2 | 4 |  | V/ns |
|  |  | Scope averaging on slow setting | 2.2 | 3 | 3.7 |  | V/ns |
| $\mathrm{Dt}_{\mathrm{RF}}$ | Slew Rate Matching ${ }^{(1,2,4)}$ | Scope averaging on |  | 7 | 15 |  | \% |
| $t_{\text {DC }}$ | Duty Cycle ${ }^{(1,2)}$ | Measured differentially, PLL Mode | 45 | 50 | 55 |  | \% |
| $\mathrm{t}_{\text {SKEW }}$ | Output Skew ${ }^{(1,2)}$ | Averaging on, $\mathrm{V}_{\mathrm{T}}=50 \%$ |  | 20 | 50 |  | ps |
| $\mathrm{tj}_{\mathrm{c}-\mathrm{c}}$ | Cycle-to-Cycle Jitter ${ }^{(1,2)}$ |  |  | 20 | 50 |  | ps |
| tjphase | Integrated Phase Jitter (RMS) $(1,5)$ | PCIe $1.0^{(6)}(2.5 \mathrm{~Gb} / \mathrm{s})$ |  | 20 | 30 | 86 | $\mathrm{ps}(\mathrm{p}-\mathrm{p})$ |
|  |  | PCIe 2.0 ( $5 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.5 | 0.6 | 3.1 | ps |
|  |  | PCIe 3.0 ( $8 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.32 | 0.42 | 1.0 | ps |
|  |  | PCIe 4.0 ( $16 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.32 | 0.4 | 0.5 | ps |
|  |  | PCIe 5.0 ( $32 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.05 | 0.06 | 0.15 | ps |
|  |  | PCIe 6.0 ( $64 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.03 | 0.04 | 0.1 | ps |
| tjph-SRISG2 | Integrated Phase Jitter (RMS) | PCIe 2.0 ( $5 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.6 | 0.92 | N/A | ps |
| tjph-SRISG3 | Integrated Phase Jitter (RMS) | PCIe 3.0 ( $8 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.5 | 0.6 | N/A | ps |
| tjph-SRISG4 | Integrated Phase Jitter (RMS) | PCIe 4.0 ( $16 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.4 | 0.5 | N/A | ps |
| tjph-SRISG5 | Integrated Phase Jitter (RMS) | PCIe 5.0 ( $32 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.06 | 0.07 | N/A | ps |
| tjph-SRISG6 | Integrated Phase Jitter (RMS) | PCIe 6.0 ( $64 \mathrm{~Gb} / \mathrm{s}$ ) |  | 0.04 | 0.05 | N/A | ps |

## Note:

1. Guaranteed by design and characterization-not $100 \%$ tested in production.
2. Measured from differential waveform.
3. Slew rate is measured through the Vswing voltage range centered around differential 0 V , within $\pm 150 \mathrm{mV}$ window.
4. It is measured using a $\pm 75 \mathrm{mV}$ window centered on the average cross point.
5. See http://www.pcisig.com for complete specs.
6. Sample size of at least 100 k cycles. This can be extrapolated to $108 \mathrm{ps} \mathrm{pk}-\mathrm{pk} @ 1 \mathrm{M}$ cycles for a BER of $10^{-12}$.

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## SMBus Serial Data Interface

The PI6CG334Q is a slave-only device that supports block read and block write protocol using a single 7-bit address and read/write bit as shown below.

Read and write block transfers can be stopped after any complete byte transfer.

## Address Assignment

| A6 | A5 | A4 | A3 | A2 | A1 | A0 | R/W |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 1 | 1 | 0 | 1 | 0 | SADR | 0 | $1 / 0$ |

Note:

1. SMBus address is latched on SADR pin.

How to Write

| $\mathbf{1}$ bit | $\mathbf{7}$ bits | $\mathbf{1}$ bit | $\mathbf{1}$ bit | $\mathbf{8}$ bits | $\mathbf{1}$ bit | $\mathbf{8}$ bits | $\mathbf{1}$ bit | $\mathbf{8}$ bits | $\mathbf{1}$ bit |  | $\mathbf{8}$ bits | $\mathbf{1}$ bit | $\mathbf{1}$ bit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Start bit | Add. | W(0) | Ack | Beginning <br> Byte loca- <br> tion = $N$ | Ack | Data Byte <br> count $=X$ | Ack | Beginning <br> Data Byte <br> $(N)$ | Ack | $\ldots \ldots .$. | Data Byte <br> $(N+X-1)$ | Ack | Stop bit |

## How to Read

| $\mathbf{1}$ bit | $\mathbf{7}$ bits | $\mathbf{1}$ bit | $\mathbf{1}$ bit | $\mathbf{8}$ bits | $\mathbf{1}$ bit | $\mathbf{1}$ bit | $\mathbf{7}$ bits | $\mathbf{1}$ bit | $\mathbf{1}$ bit | $\mathbf{8}$ bits | $\mathbf{1}$ bit | $\mathbf{8}$ bits | $\mathbf{1}$ bit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Start bit | Address | W(0) | Ack | Beginning <br> Byte loca- <br> tion $=N$ | Ack | Repeat <br> Start bit | Address | R(1) | Ack | Data Byte <br> count $=X$ | Ack | Beginning <br> Data Byte <br> (N) | Ack |


|  | $\mathbf{8}$ bits | $\mathbf{1}$ bit | $\mathbf{1}$ bit |
| :--- | :--- | :--- | :--- |
| $\ldots \ldots$. | Data Byte <br> $(N+X-1)$ | NAck | Stop bit |

## Byte 0: Output Enable Register

| Bit | Control Function | Description | Type | Power-up Condition | 0 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | Reserved | - | - | 1 | See B11[1:0] | - |
| 6 | Q3_OE | Q3 output enable | RW | 1 |  | Pin Control |
| 5 | Q2_OE | Q2 output enable | RW | 1 |  | Pin Control |
| 4 | Reserved | - | - | 1 |  | - |
| 3 | Q1_OE | Q1 output enable | RW | 1 |  | Pin Control |
| 2 | Reserved | - | - | 1 |  | - |
| 1 | Q0_OE | Q0 output enable | RW | 1 |  | Pin Control |
| 0 | Reserved | - | - | 1 |  | - |

## Note:

1. A low on these bits will override the OE\# pins and force the differential outputs to the state indicated by B11[1:0] (Low/ Low default).

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Byte 1: SS Spread Spectrum and Control Register

| Bit | Control Function | Description | Type | Power-up Condition | 0 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | SSENRB1 | SS Enable Readback Bit1 | R | Latch | $\begin{aligned} & \text { '00' for SS_SEL_TRI = '0', } \\ & \text { '10' for SS_SEL_TRI = 'M', '11' } \\ & \text { for SS_SEL_TRI ='1' } \end{aligned}$ |  |
| 6 | SSENRB0 | SS Enable Readback Bit0 | R | Latch |  |  |
| 5 | SSEN_SWCTR | Enable SW control of SS | RW | 0 | Values in B1[7:6] control SS amount | Values in B1[4:3] control SS amount |
| 4 | SSENSW1 | SS enable SW control Bit1 | RW ${ }^{(1)}$ | 0 | $\begin{aligned} & \text { '00' = SS off, '01' = }-0.25 \% \text { SS, } \\ & ' 10 '=\text { SS off, '11' }=-0.5 \% \text { SS } \end{aligned}$ |  |
| 3 | SSENSW0 | SS enable SW control Bit0 | RW ${ }^{(1)}$ | 0 |  |  |
| 2 | Reserved | - | - | 1 | - | - |
| 1 | Amplitudel | Control output amplitude | RW | 1 | $\begin{aligned} & ' 00 '=0.6 \mathrm{~V}, ' 01 '=0.68 \mathrm{~V}, ' 10 '= \\ & 0.75 \mathrm{~V}, ' 11 '=0.85 \mathrm{~V} \end{aligned}$ |  |
| 0 | Amplitude0 |  | RW | 0 |  |  |

## Note:

1. Spread must be selected OFF or ON with the hardware latch pin. These bits must not be used to turn spread ON or OFF after power up. These bits can be used to change the spread amount, and B1[5] must be set to a 1 for these bits to have any effect on the part. If these bits are used to turn spread OFF or ON, the system must be reset.

Byte 2: Differential Output Slew Rate Control Register

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| 7 | Reserved | - | - | 1 | - |  |
| 6 | SLEWRATECTR_Q3 | Control slew rate of Q3 | RW | 1 | Slow setting | Fast setting |
| 5 | SLEWRATECTR_Q2 | Control slew rate of Q2 | RW | 1 | Slow setting | Fast setting |
| 4 | Reserved | - | - | 1 | - | - |
| 3 | SLEWRATECTR_Q1 | Control slew rate of Q1 | RW | 1 | Slow setting | Fast setting |
| 2 | Reserved | - | - | 1 | - | - |
| 1 | SLEWRATECTR_Q0 | Control slew rate of Q0 | RW | 1 | Slow setting | Fast setting |
| 0 | Reserved | - | - | 1 | - |  |

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## Byte 3: REF Control Register

| Bit | Control Function | Description | Type | Power-up Condition | 0 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | REFSLEWRATE | Slew rate control for REF | RW | 0 | $\begin{aligned} & \prime 00^{\prime}=1.4 \mathrm{~V} / \mathrm{ns} \text { ' } 01^{\prime}=2.4 \mathrm{~V} / \mathrm{ns}, \\ & ' 10^{\prime}=3 \mathrm{~V} / \mathrm{ns}, ~ \\ & \hline 11^{\prime}=3.2 \mathrm{~V} / \mathrm{ns} \end{aligned}$ |  |
| 6 |  |  | RW | 1 |  |  |
| 5 | REF_PDSTATE | Wake-on-Lan enable for REF | RW | 0 | $\begin{aligned} & \text { REF = Dis- } \\ & \text { abled in PD } \\ & \text { state }^{(1)} \end{aligned}$ | $\begin{aligned} & \text { REF = run- } \\ & \text { ning in PD } \\ & \text { state } \end{aligned}$ |
| 4 | REF_OE | Output enable for REF | RW | 1 | $\begin{aligned} & \text { REF = Dis- } \\ & \text { abled }^{(1)} \end{aligned}$ | $\begin{aligned} & \text { REF = run- } \\ & \text { ning } \end{aligned}$ |
| 3 | Reserved | - | - | 1 | - | - |
| 2 | Reserved | - | - | 1 | - | - |
| 1 | Reserved | - | - | 1 | - | - |
| 0 | Reserved | - | - | 1 | - | - |

Note:

1. The disabled state depends on Byte11[1:0]. '00' = Low, '01'=HiZ, '10'=Low, '11'=High.

## Byte 4: Reserved

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| $7: 0$ | Reserved | - | - | $0 \times 40$ | - | - |

Byte 5: Revision and Vendor ID Register

| Bit | Control Function | Description | Type | Power-up Condition | 0 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | RID3 | Revision ID | R | 0 | $\mathrm{rev}=0000$ |  |
| 6 | RID2 |  | R | 0 |  |  |
| 5 | RID1 |  | R | 0 |  |  |
| 4 | RID0 |  | R | 0 |  |  |
| 3 | PVID3 | Vendor ID | R | 0 | Diodes $=0011$ |  |
| 2 | PVID2 |  | R | 0 |  |  |
| 1 | PVID1 |  | R | 1 |  |  |
| 0 | PVID0 |  | R | 1 |  |  |

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## Byte 6: Device Type/Device ID Register

| Bit | Control Function | Description | Type | Power-up Condition | 0 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | DTYPE1 | Device type | R | 0 | $\begin{aligned} & \text { '00' = CG, '01' = ZDB, } \\ & \text { '10' = Reserve, '11' = NZDB } \end{aligned}$ |
| 6 | DTYPE0 |  | R | 0 |  |
| 5 | DID5 | Device ID | R | 0 | 001000 binary, 08Hex |
| 4 | DID4 |  | R | 0 |  |
| 3 | DID3 |  | R | 1 |  |
| 2 | DID2 |  | R | 0 |  |
| 1 | DID1 |  | R | 0 |  |
| 0 | DID0 |  | R | 0 |  |

Byte 7: Byte Count Register

| Bit | Control Function | Description | Type | Power-up Condition | 0 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | Reserved | - | - | 0 | - | - |
| 6 | Reserved | - | - | 0 | - | - |
| 5 | Reserved | - | - | 0 | - | - |
| 4 | BC4 | Byte count programming | RW | 0 | Writing to this register will configure how many bytes will be read back, default is 8 bytes |  |
| 3 | BC3 |  | RW | 1 |  |  |
| 2 | BC2 |  | RW | 0 |  |  |
| 1 | BC1 |  | RW | 0 |  |  |
| 0 | BC0 |  | RW | 0 |  |  |

Byte 8 and 9: Reserved

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| $7: 0$ | Reserved | - | - | B8:0x36 <br> $B 9: 0 x 00$ | - | - |

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## Byte 10: PD Restore

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| 7 | Reserved | - | - | 0 | - | - |
| 6 | PD Restore | PD Restore to default configuration | RW | 1 | Clear PD <br> Config | Keep PD <br> Config |
| $5: 0$ | Reserved | - | - | 0 | - | - |

## Byte 11: Stop Control

| Bit | Control Function | Description | Type | Power-up Condition | 0 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7:2 | Reserved | - | - | 0 | - | - |
| 1 | STP1 | True/ Compliment DIF Output Disable Sate | RW | 0 | 00= Low/Low | $10=\mathrm{High} /$ <br> Low |
| 0 | STP0 |  | RW | 0 | 01 $=\mathrm{HiZ} / \mathrm{HiZ}$ | 11= Low/High |

## Byte 12: Impedance Control

| Bit | Control Function | Description | Type | Power-up Condition | 0 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | Q1_Zout1 | Q1 Zout | RW | 10 | $\begin{aligned} 00 & =\text { Reserved } \\ 01 & =85 \Omega \\ 10 & =100 \Omega \\ 11 & =\text { Reserved } \end{aligned}$ |  |
| 6 | Q1_Zout0 | Q1 Zout | RW |  |  |  |
| 5 | Reserved |  |  |  |  |  |
| 4 | Reserved |  |  |  |  |  |
| 3 | Q0_Zout1 | Q0 Zout | RW |  |  |  |
| 2 | Q0_Zout0 | Q0 Zout | RW |  |  |  |
| 1 | Reserved |  |  |  |  |  |
| 0 | Reserved |  |  |  |  |  |

## Byte 13: Impedance Control



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## Byte 14: OE Termination Control

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| 7 | OE1_term1 | OE1 pullup or down | RW | 0 | $00=$ None | $10=$ Pullup |
| 6 | OE1_term0 | OE1 pullup or down | RW | 1 | $01=$ Pulldown | $11=$ Pullup <br> and Down |
| 5 | Reserved | - | - | 0 | - | - |
| 4 | Reserved | - | - | 1 | - | - |
| 3 | OE0_term1 | OE0 pullup or down | RW | 0 | $00=$ None | $10=$ Pullup |
| 2 | OE0_term0 | OE0 pullup or down | - | 1 | $01=$ Pulldown | $11=$ Pullup <br> and Down |
| 1 | Reserved | - | - | 1 | - | - |
| 0 | Reserved | - | 0 | - |  |  |

Byte 15: OE Termination Control

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| 7 | Reserved | - | - | 0 | - | - |
| 6 | Reserved | - | - | 1 | - | - |
| 5 | OE3_term1 | OE3 pullup or down | RW | 0 | $00=$ None | $10=$ Pullup |
| 4 | OE3_term0 | OE3 pullup or down | RW | 1 | $01=$ Pulldown | $11=$ Pullup <br> and Down |
| 3 | OE2_term1 | OE2 pullup or down | RW | 0 | $00=$ None | $10=$ Pullup |
| 2 | OE2_term0 | OE2 pullup or down | RW | 1 | $01=$ Pulldown | $11=$ Pullup <br> and Down |
| 1 | Reserved | - | - | 0 | - | - |
| 0 | Reserved | - | - | 1 | - | - |

## Byte 16: Power Good Termination Control

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| $7: 2$ | Reserved | - | - | $0 \times 09$ | - | - |
| 1 | PWRGD_PD1 | Clock power good and power-down pullup or |  |  |  |  |
|  | pulldown | RW | 1 | $00=$ None | $10=$ Pullup |  |
| 0 | PWRGD_PD0 | RW | 0 | $00=$ Pulldown | $11=$ Pullup <br> and Down |  |

## Byte 17: Reserved

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## Byte 18: Enable Pin Control

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| 7 | Reserved | - | - | 0 | - | - |
| 6 | OE3_Enable | Sets Enable High or Low | RW | 0 | Enable $=$ Low | Enable $=$ High |
| 5 | OE2_Enable | Sets Enable High or Low | RW | 0 | Enable $=$ Low | Enable $=$ High |
| 4 | Reserved | - | - | 0 | - | - |
| 3 | OE1_Enable | Sets Enable High or Low | RW | 0 | Enable $=$ Low | Enable $=$ High |
| 2 | Reserved | - | - | 0 | - | - |
| 1 | OE0_Enable | Sets Enable High or Low | RW | 0 | Enable $=$ Low | Enable $=$ High |
| 0 | Reserved | - | - | 0 | - |  |

Byte 19: Power Down Pin Control

| Bit | Control Function | Description | Type | Power-up <br> Condition | $\mathbf{0}$ | $\mathbf{1}$ |
| :--- | :--- | :--- | :---: | :---: | :--- | :--- |
| $7: 1$ | Reserved | - | - | 0 | - | - |
| 0 | PWRGD_PD | PWRGD_PD Active via Pullup or Pulldown | RW | 0 | Power Down <br> $=$ Low | Power Down <br> $=$ High |

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## Phase Noise Plots

## 100 MHz HCSL Clock ( 12 k to 20 MHz )



## 25MHz CMOS Clock



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Low-Power HCSL Differential Output Test Load


Figure 1. Low Power HCSL Test Circuit


Figure 2. CMOS REF Test Circuit


Figure 3. Differential Output Driving LVDS
Alternate Differential Output Terminations

| Component | Receiver with Termination | Receiver without Termination | Unit |
| :--- | :--- | :--- | :---: |
| $\mathrm{R}_{1 \mathrm{a},} \mathrm{R}_{1 \mathrm{~b}}$ | 10,000 | 140 | $\Omega$ |
| $\mathrm{R}_{2 \mathrm{a},} \mathrm{R}_{2 \mathrm{~b}}$ | 5600 | 75 | $\Omega$ |
| $\mathrm{C}_{\mathrm{C}}$ | 0.1 | 0.1 | $\mu \mathrm{~F}$ |
| $\mathrm{~V}_{\mathrm{CM}}$ | 1.2 | 1.2 | V |



Figure 4. Power Supply Filter

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## Crystal Circuit Connection

The following diagram shows PI6CG334Q crystal circuit connection with a parallel crystal. For the CL $=8 \mathrm{pF}$ crystal, it is suggested to use $\mathrm{C} 1=8 \mathrm{pF}$ and $\mathrm{C} 2=8 \mathrm{pF}$. C 1 and C 2 can be adjusted to fine tune to the target ppm of crystal oscillator according to different board layouts based on the following formula in the Crystal Capacitor Calculation diagram.

## Crystal Oscillator Circuit



## Crystal Capacitor Calculation



Final chooseltrim C1=C2=2 *CL - (Cb +Cj$)$ for the target $+/$-ppm
Example: $\mathrm{C} 1=\mathrm{C} 2=2^{*}(18 \mathrm{pF})-(4 \mathrm{pF}+5 \mathrm{pF})=27 \mathrm{pF}$

## Recommended Crystal Specification

## Diodes Recommends:

a) FL2500262Q, SMD $3.2 \times 2.5(4 \mathrm{P}), 25 \mathrm{MHz}, \mathrm{CL}=8 \mathrm{pF}, \pm 50 \mathrm{ppm}$, https://www.diodes.com/assets/Datasheets/FL.pdf.
b) FW2500054Q, SMD $2.0 \mathrm{x} 1.6(4 \mathrm{P}), 25 \mathrm{MHz}, \mathrm{CL}=8 \mathrm{pF}, \pm 50 \mathrm{ppm}$, https://www.diodes.com/assets/Datasheets/FW.pdf.

## Thermal Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
| :--- | :--- | :--- | :--- | :---: | :---: | :---: |
| $\theta_{\text {JA }}$ | Thermal Resistance Junction to Ambient | Still air |  |  | 44.7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {JC }}$ | Thermal Resistance Junction to Case |  |  |  | 21.7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

PI6CG334Q

## Part Marking

|  | PI6CG33 <br> 4Q2ZHWE <br> YYWWX <br> 0 |
| :--- | :--- |
| YY: Year |  |
| WW: Workweek |  |
| 1st X:Assembly Code |  |
| 2nd X: Fab Code |  |

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## Packaging Mechanical

32-WQFN (ZHW)


For latest package information:
See http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/.

## Ordering Information

| Ordering Code | Package Code | Package Description | Operating Temperature |
| :--- | :---: | :--- | :---: |
| PI6CG334Q2ZHWEX | ZHW | W-QFN5050-32 (SWP) | $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$ |

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) \& 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine $(<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl})$ and $<1000 \mathrm{ppm}$ antimony compounds.
4. $\mathrm{Q}=$ Automotive Compliant
5. $2=$ AEC-Q100 Grade Level
6. $\mathrm{E}=\mathrm{Pb}$-free and Green
7. X suffix $=$ Tape $/$ Reel

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## IMPORTANT NOTICE


#### Abstract

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[^0]:    Notes:

    1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) \& 2015/863/EU (RoHS 3) compliant.
    2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
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